

WEST Search History**[Hide Items] [Restore] [Clear] [Cancel]**

DATE: Monday, October 25, 2004

<u>Hide?</u>	<u>Set</u>	<u>Name</u>	<u>Query</u>	<u>Hi</u>	<u>Cou</u>
<i>DB=USPT; PLUR=YES; OP=OR</i>					
<input type="checkbox"/>	L10	L9 and (releas\$3 or peel\$3 or separat\$4 or detach\$4 or transfer\$4 or remov\$4)		7	
<input type="checkbox"/>	L9	L8 and flexible		8	
<input type="checkbox"/>	L8	L7 and (stainless or polyimide or polyester)		23	
<input type="checkbox"/>	L7	L5 or L6		79	
<input type="checkbox"/>	L6	257/618,619,678,679.ccls.		16	
<input type="checkbox"/>	L5	438/106,118,121-127,455,457,458,478,479,482,483,486.ccls.		64	
<i>DB=PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD; PLUR=YES; OP=OR</i>					
<input type="checkbox"/>	L4	L3 and ((substrate or film) with (polyster or stainless or polyimide))		8	
<input type="checkbox"/>	L3	L2 and (peel\$3 or transfer\$4 or remov\$5 or etch\$4 or separat\$3 or cleav\$4)		12	
<input type="checkbox"/>	L2	L1 and ((semiconductor or silicon) with (film or layer) with (thick or thickness))		12	
<input type="checkbox"/>	L1	(form\$3 with (amorphous or semiconductor or silicon) with (oxide or nitride)) and ((substrate or display) with flexible) and (polyster or polyimide or stainless or adhesive)		21	

END OF SEARCH HISTORY

	Type	Hits	Search Text	DBs
1	BRS	2017	(flexible adj (substrate or film)) and insulat\$3 and (separat\$3 or cleav\$3) and semiconductor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
2	BRS	2252	((stainless or polyimide or polyester) and ((separat\$3 or cleav\$4 or etch\$3) with semiconductor with (layer or film)) and (flex\$4 or bend\$4 or bent))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
3	BRS	1953	((stainless or polyimide or polyester) and ((separat\$3 or cleav\$4 or etch\$3) with semiconductor with (layer or film)) and (flex\$4 or bend\$4 or bent)) and (adhesive or spread\$3 or coat\$3 or peel\$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
4	BRS	1705	((stainless or polyimide or polyester) and ((separat\$3 or cleav\$4 or etch\$3) with semiconductor with (layer or film)) and (flex\$4 or bend\$4 or bent)) and (adhesive or spread\$3 or coat\$3 or peel\$3)) and ((thicker or thickest or thick or thickness) with (layer or film))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
5	BRS	135	((stainless or polyimide or polyester) and ((separat\$3 or cleav\$4 or etch\$3) with semiconductor with (layer or film)) and (flex\$4 or bend\$4 or bent)) and (adhesive or spread\$3 or coat\$3 or peel\$3)) and ((thicker or thickest or thick or thickness) with (layer or film))) and (nickel and amorphous)	USPAT